IGBT - Field Stop, Trench

650 V, 40 A

FGH40T65UPD

Description

Using innovative field stop trench IGBT technology, ON Semiconductor's new series of field-stop trench IGBTs offer optimum performance for solar inverter, UPS, welder, and digital power generator where low conduction and switching losses are essential.

Features

- Maximum Junction Temperature: $T_J = 175^{\circ}C$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.65 V(Typ.) @ I_C = 40 A$
- 100% of Parts Tested I_{LM} (Note 2)
- High Input Impedance
- Tightened Parameter Distribution
- Short Circuit Ruggedness > 5 μs @ 25°C
- This Device is Pb-Free and is RoHS Compliant

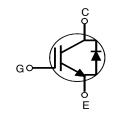
Applications

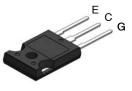
- Solar Inverter, UPS, Welder, Digital Power Generator
- Telecom, ESS



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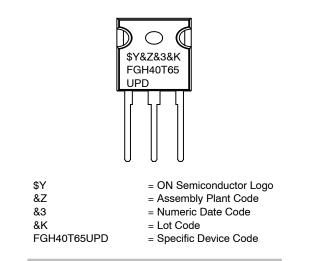
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TO-247-3LD CASE 340CK

MARKING DIAGRAMS



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Descriptio	Symbol	Ratings	Unit	
Collector to Emitter Voltage		V _{CES}	650	V
Gate to Emitter Voltage		V _{GES}	±20	V
Transient Gate to Emitter Voltage	1 f	±25	V	
Collector Current	$T_{\rm C} = 25^{\circ}{\rm C}$	Ι _C	80	А
Collector Current	T _C = 100°C	1 f	40	А
Pulsed Collector Current (Note 1)	•	I _{CM}	120	А
Clamped Inductive Load Current (Note 2)	$T_{\rm C} = 25^{\circ}{\rm C}$	I _{LM}	120	А
Diode Forward Current	$T_{\rm C} = 25^{\circ}{\rm C}$	١ _F	40	А
Diode Forward Current	$T_{\rm C} = 100^{\circ}{\rm C}$	1 f	20	А
Pulsed Diode Maximum Forward Current (No	ote 1)	I _{FM}	120	А
Maximum Power Dissipation $T_{C} = 25^{\circ}C$		PD	268	W
Maximum Power Dissipation	$T_{\rm C} = 100^{\circ}{\rm C}$	1 f	134	W
Short Circuit Withstand Time	$T_{\rm C} = 25^{\circ}{\rm C}$	SCWT	5	μs
Operating Junction Temperature	TJ	–55 to +175	°C	
Storage Temperature Range	T _{stg}	–55 to +175	°C	
Maximum Lead Temp. for Soldering Purpose	ΤL	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
Repetitive rating: Pulse width limited by max. junction temperature.
Ic = 120 A, Vce = 400 V, Rg = 15 Ω

THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction to Case (IGBT)	$R_{\theta JC}$	0.56	°C/W
Thermal Resistance, Junction to Case (Diode)	$R_{\theta JC}$	1.71	°C/W
Thermal Resistance, Junction to Ambient	$R_{ hetaJA}$	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH40T65UPD	FGH40T65UPD	TO-247-3LD	Tube	N/A	N/A	30

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Parameter	Symbol	ol Test Conditions		Тур	Max	Unit	
DFF CHARACTERISTICS							
Collector to Emitter Breakdown Voltage	BV _{CES}	V _{GE} = 0 V, I _C = 1 mA	650	-	-	V	
Temperature Coefficient of Breakdown Voltage	$\Delta {\rm BV}_{\rm CES} / \Delta {\rm T}_{\rm J}$	V_{GE} = 0 V, I _C = 250 µA		0.65		V/°C	
Collector Cut-Off Current	I _{CES}	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA	
G-E Leakage Current	I _{GES}	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA	
ON CHARACTERISTICS							
G-E Threshold Voltage	V _{GE(th)}	I_{C} = 40 mA, V_{CE} = V_{GE}	4.0	6.0	7.5	V	
Collector to Emitter Saturation Voltage	V _{CE(sat)}	I _C = 40 A, V _{GE} = 15 V	-	1.65	2.3	V	
		I_{C} = 40 A, V_{GE} = 15 V, T_{C} = 175°C	-	2.1	-	V	

ELECTRICAL CHARACTERISTICS OF THE IGB	Γ (T _C = 25°C unless otherwise noted) (continued)
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Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
DYNAMIC CHARACTERISTICS		·				
Input Capacitance	C _{ies}	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	-	2730	3630	pF
Output Capacitance	C _{oes}	1	-	82	110	pF
Reverse Transfer Capacitance	C _{res}	1	-	48	72	pF
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A},$	-	20	26	ns
Rise Time	t _r	$R_G = 7 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$	-	26	34	ns
Turn-Off Delay Time	t _{d(off)}	1	-	144	187	ns
Fall Time	t _f	1	-	17	22	ns
Turn-On Switching Loss	E _{on}	1	-	1.59	2.1	mJ
Turn-Off Switching Loss	E _{off}	1	-	0.58	0.76	mJ
Total Switching Loss	E _{ts}	1	-	2.17	2.86	mJ
Turn-On Delay Time	t _{d(on)}	$V_{\rm CC} = 400 \text{ V}, \text{ I}_{\rm C} = 40 \text{ A},$	-	19	-	ns
Rise Time	t _r	$R_G = 7 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 175^{\circ}C$	-	38	-	ns
Turn-Off Delay Time	t _{d(off)}	1	-	153	-	ns
Fall Time	t _f	1	-	60	-	ns
Turn-On Switching Loss	E _{on}	1	-	1.84	-	mJ
Turn–Off Switching Loss	E _{off}	1	-	0.98	-	mJ
Total Switching Loss	E _{ts}	1	-	2.82	-	mJ
Short Circuit Withstand Time	Tsc	V_{GE} = 15 V, V_{CC} \leq 400 V, Rg = 10 Ω	5	-	-	μs
Total Gate Charge	Qg	V_{CE} = 400 V, I _C = 40 A, V _{GE} = 15 V	-	177	265	nC
Gate to Emitter Charge	Q _{ge}	1	-	23	35	nC
Gate to Collector Charge	Q _{gc}	1	-	100	150	nC

ELECTRICAL CHARACTERISTICS OF THE DIODE (T_C = 25° C unless otherwise noted)

Parameter	Symbol	Test Conditions		Min	Тур	Max	Unit
Diode Forward Voltage	V _{FM}	I _F = 20 A	$T_{C} = 25^{\circ}C$	-	2.1	2.7	V
			T _C = 175°C	-	1.9	-	
Reverse Recovery Energy	E _{rec}	I _F = 20 A, di _F /dt = 200 A/μs	T _C = 175°C	-	96	-	μJ
Diode Reverse Recovery Time	t _{rr}		$T_{C} = 25^{\circ}C$	-	33	43	ns
			T _C = 175°C	-	128	-	1
Diode Reverse Recovery Charge	Q _{rr}		$T_{C} = 25^{\circ}C$	-	53	74	nC
			T _C = 175°C	-	341	-	1

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

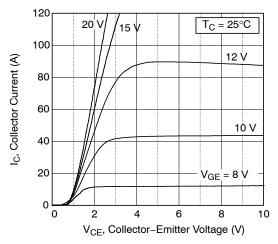


Figure 1. Typical Output Characteristics

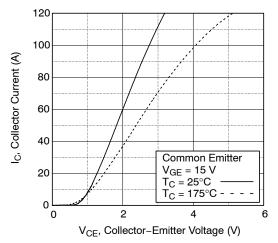


Figure 3. Typical Saturation Voltage Characteristics

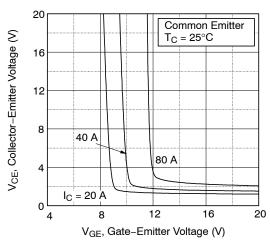


Figure 5. Saturation Voltage vs. V_{GE}

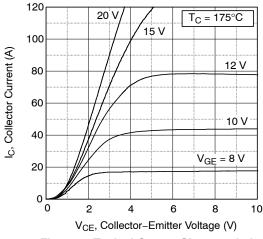


Figure 2. Typical Output Characteristics

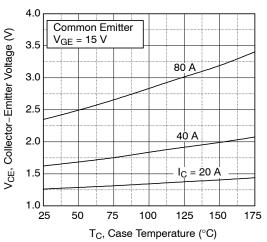
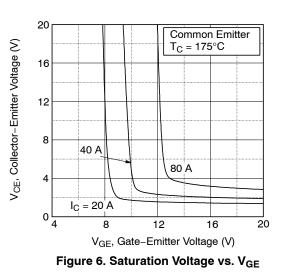


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level



TYPICAL PERFORMANCE CHARACTERISTICS (continued)

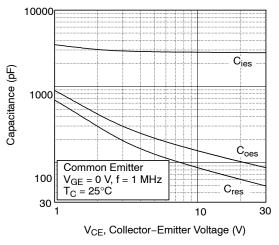


Figure 7. Capacitance Characteristics

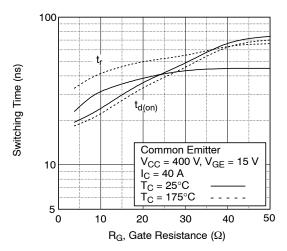


Figure 9. Turn-On Characteristics vs. Gate Resistance

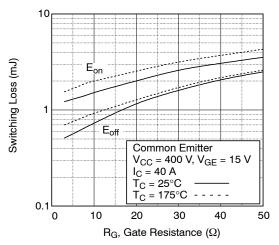


Figure 11. Switching Loss vs. Gate Resistance

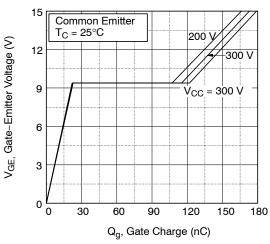


Figure 8. Gate Charge Characteristics

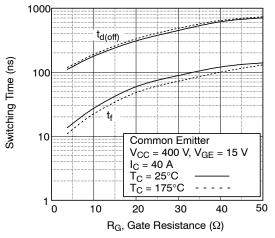


Figure 10. Turn-Off Characteristics vs. Gate Resistance

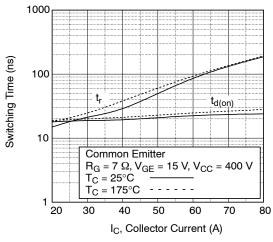


Figure 12. Turn-On Characteristics vs. Collector Current

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

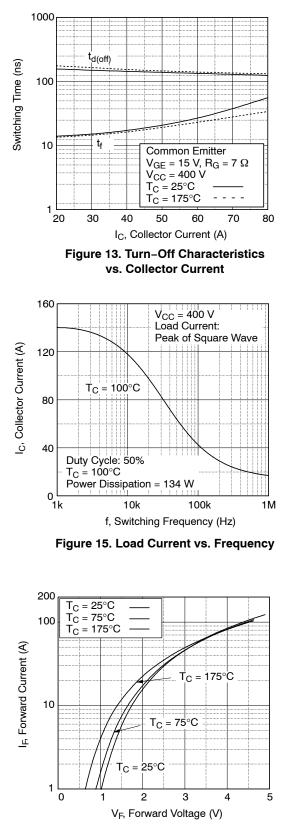


Figure 17. Forward Characteristics

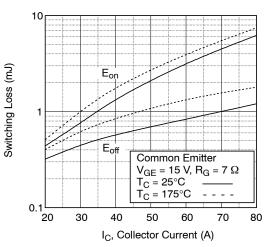


Figure 14. Switching Loss vs. Collector Current

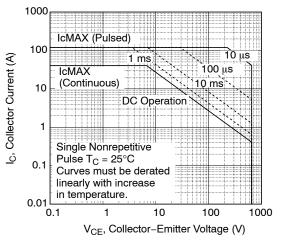
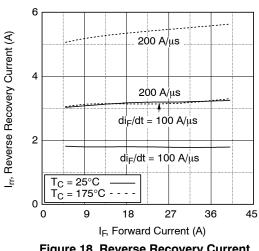


Figure 16. SOA Characteristics





TYPICAL PERFORMANCE CHARACTERISTICS (continued)

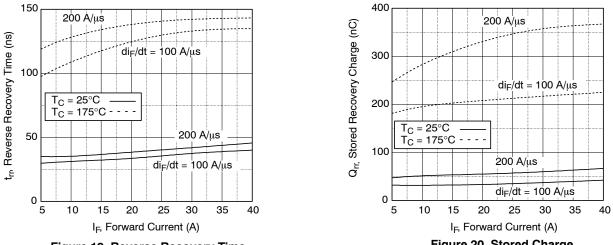


Figure 19. Reverse Recovery Time



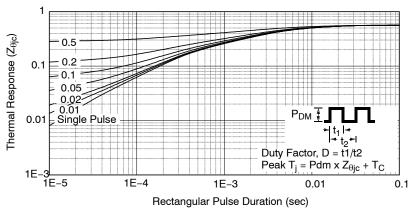


Figure 21. Transient Thermal Impedance of IGBT

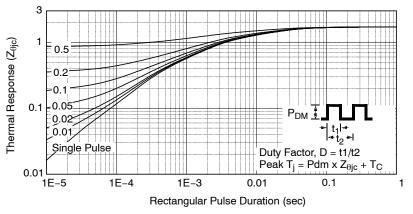


Figure 22. Transient Thermal Impedance of Diode





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